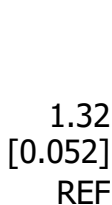
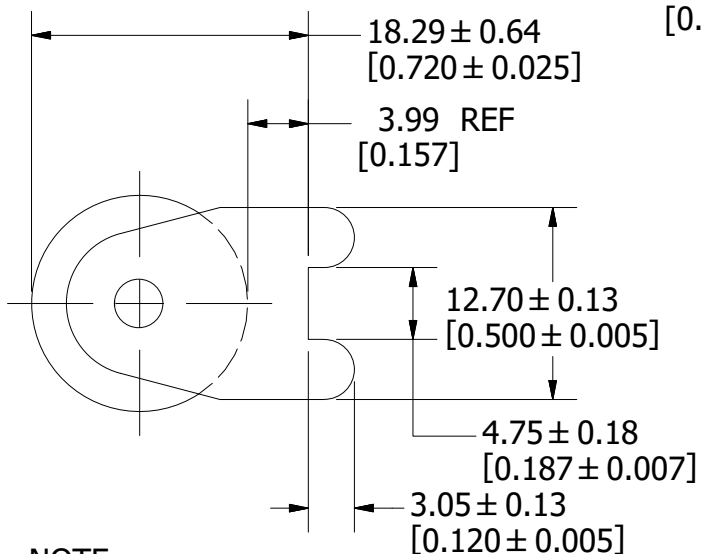
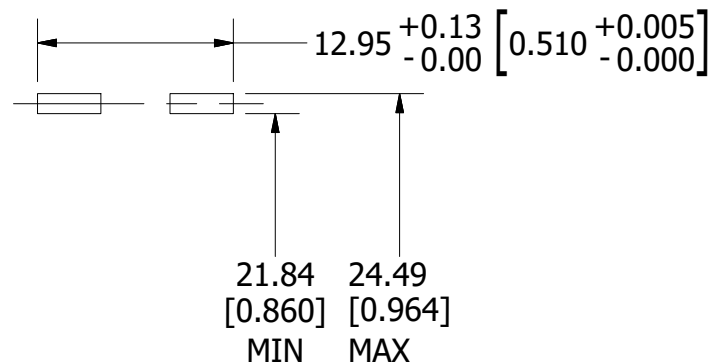
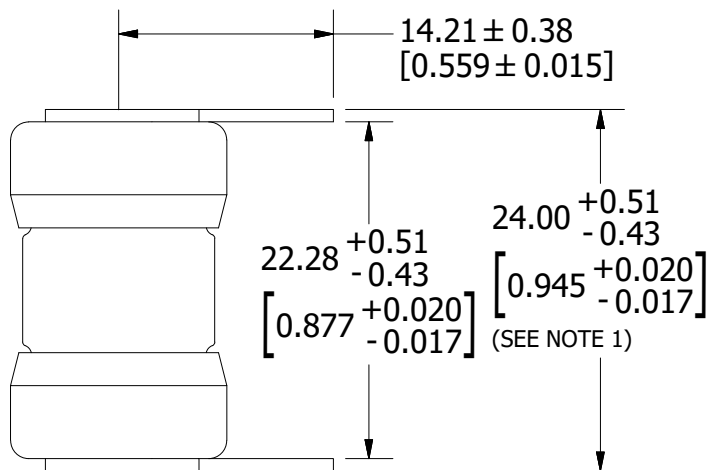


REVISION		
REV	DATE	DESCRIPTION
H	10/20/20	522885ECP/D - REDRAW IN INVENTOR, ADD METRIC DIMENSIONS MRY



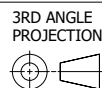
PAD LAYOUT

<S>	CRITICAL CHARACTERISTIC FOR PART SAFETY/COMPLIANCE
●	DENOTES CRITICAL CHARACTERISTICS.
CPK	DENOTES CPK DIMENSIONS, -MINIMUM CPK VALUE
ST	DENOTES A CHARACTERISTIC THAT PROVIDES AN INDICATION OF PROCESS PERFORMANCE. PROCEDURE FOR MEASUREMENT AND TRACKING TO BE DEFINED IN LITTELFUSE INSPECTION INSTRUCTIONS.
CP	DENOTES CP DIMENSIONS, -MINIMUM CP VALUE MUST BE WITHIN THE DIMENSIONAL LIMITATIONS SHOWN ON DRAWING AND INITIALLY LOCATED TO ALLOW FOR MAXIMUM TOOL LIFE.

A

MATL SPEC		FINISH	
DRW myork	DATE 9/22/2020	SCALE NTS	FINISH GOOD WT GRAMS/PIECE

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN MILLIMETERS, DIMENSIONS IN BRACKETS [] ARE INCHES DIMENSIONING AND DO NOT INCLUDE PLATING. TOLERANCING TO BE INTERPRETED IN ACCORDANCE WITH ANSI Y14.5M-1994



TITLE

TLS-LS OUTLINE & PAD LAYOUT



REVISION	DRWG NO.	SHEET 1 OF 1
H	OL-0TLS000LS	

NOTE:
1. MEASUREMENT TAKEN AT END OF TERMINALS.

LEAD-FREE SOLDERING PROFILE:
PRE-HEAT: ABOVE 130°C FOR 75 SECONDS MAX
REFLOW: 278°C FOR 8 SECONDS MAX
TIME: 250 SECONDS MAX.
MAX. TEMP: 280°C